



# AP1019

## 9.0V Dual H-Bridge Motor Driver IC

### 1. General Description

The AP1019 is a dual H-Bridge Motor Driver to operate up to 9.0V power supply. It has four drive modes of operation; Forward, Reverse, Brake and Standby. It is capable to configure the input logic which is suitable for the PWM drive with the SEL terminal. The driver works up to 1MHz, therefore it can suppress the current ripple and reduce the motor sound.

The AP1019 has an N-ch LDMOS FET for both high side and low side of the output circuit, realizing to adopt a small WL-CSP package. In addition, the AP1019 has under-voltage detection and thermal shutdown circuits. It is suitable for driving various small motors.

### 2. Features

- |                                   |                               |
|-----------------------------------|-------------------------------|
| • Wide Motor Driving Voltage      | 2.0V to 9.0V                  |
| • Power Supply Voltage            | 2.7V to 5.5V                  |
| • Maximum Output Current (DC)     | 1.1A (max)                    |
| • Maximum Output Current (Peak)   | 2.0A (Ta=25°C, 10ms/200ms)    |
| • H-Bridge ON Resistance          | RON (TOP+BOT)=0.35Ω @Ta=25°C  |
| • PWM Operation Frequency         | 1MHz(max)                     |
| • Under Voltage Detection Circuit |                               |
| • Thermal Shut Down Circuit       |                               |
| • Operation Temperature Range     | -30 ~ 85°C                    |
| • Package                         | 16-pin WLCSP (1.96mm×1.96mm ) |

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4. Block Diagram

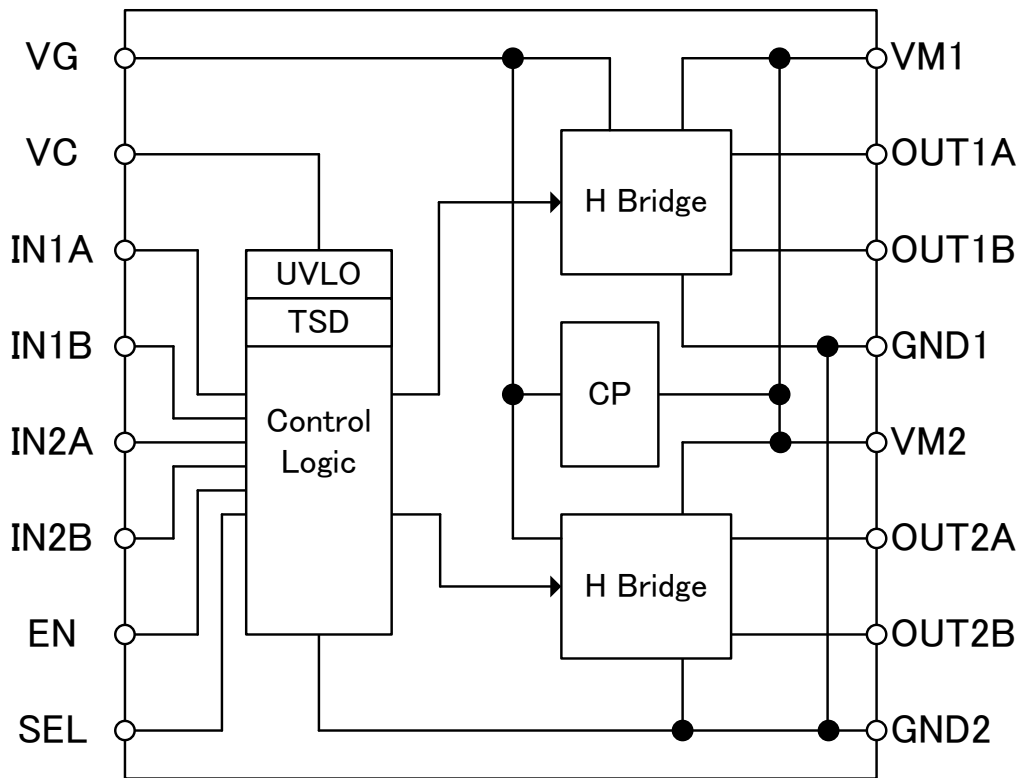
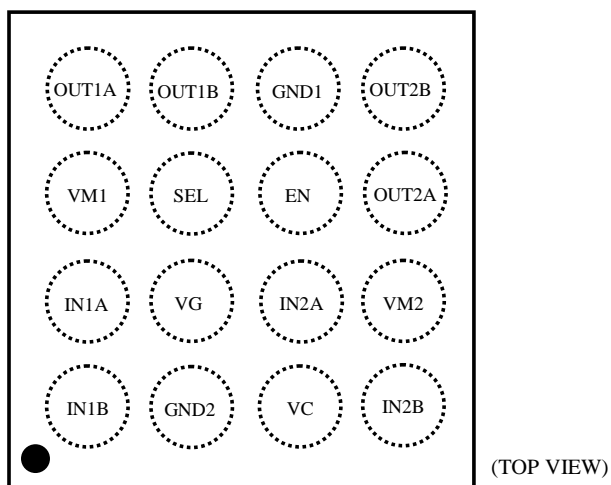


Figure 1. Block Diagram

## 5. Pin Configurations and Functions

### 5.1. Pin Configurations



### 5.2. Functions

Pin Number	Name	I/O (Note 1)	Functions	Remarks
A1	IN1B	I	Control signal input terminal	
A2	IN1A	I	Control signal input terminal	
A3	VM1	P	Motor driver power supply	(Note 2)
A4	OUT1A	O	Motor driver output Terminal	
B1	GND2	P	Power ground terminal	(Note 3)
B2	VG	P	Charge pump output capacitor connection terminal	
B3	SEL	I	Input logic selection terminal	200kΩ Pull-down
B4	OUT1B	O	Motor driver output Terminal	
C1	VC	P	Control power supply	
C2	IN2A	I	Control signal input terminal	
C3	EN	I	Enable signal input terminal	200kΩ Pull-down
C4	GND1	P	Power ground terminal	(Note 3)
D1	IN2B	I	Control signal input terminal	
D2	VM2	P	Motor driver power supply	(Note 2)
D3	OUT2A	O	Motor driver output Terminal	
D4	OUT2B	O	Motor driver output Terminal	

Note 1. I (Input terminal), O (Output terminal) and P (Power terminal)

Note 2. Connect the VM1 and VM2 terminals on the PCB. These terminals must be connected to the same power supply voltage.

Note 3. Connect the GND1 and GND2 terminals on the PCB. These terminals must be connected to the same ground.

**6. Absolute Maximum Ratings**

Parameter	Symbol	Min.	Max.	Unit	Condition
Control Supply Voltage	VC	-0.3	6.0	V	
Motor Supply Voltage	VM	-0.3	9.5	V	
VC Level Terminal Voltage (INnA, IN1nB, SEL and EN )	$V_{terminal1}$	-0.3	VC	V	
VM level Terminal Voltage (OUTnA and OUTnB)	$V_{terminal2}$	-0.3	VM	V	
VC+VM Level Terminal Voltage (VG)	$V_{terminal3}$	-0.3	15.5	V	
Maximum Output Current @2ch drive	$I_{loaddcMD}$	-	1.1	A/ch	Ta = 25°C
		-	0.8	A/ch	Ta = 85°C
Maximum Output Current @1ch drive	$I_{loaddcMD}$	-	1.5	A	Ta = 25°C
		-	1.1	A	Ta = 85°C
Maximum Output Peak Current	$I_{loadpeakMD}$	-	2.0	A	Within 10ms during 200ms
Power Dissipation	PD	-	1760	mW	Ta = 25°C (Note 5)
		-	915	mW	Ta = 85°C (Note 5)
Junction Temperature	Tj		150	°C	
Storage Temperature	Tstg	-65	150	°C	

Note 4. All above voltage are with respect to GND.

Note 5. This is calculated as  $R\theta_J = 71^\circ\text{C/W}$  using a 2-layer board.

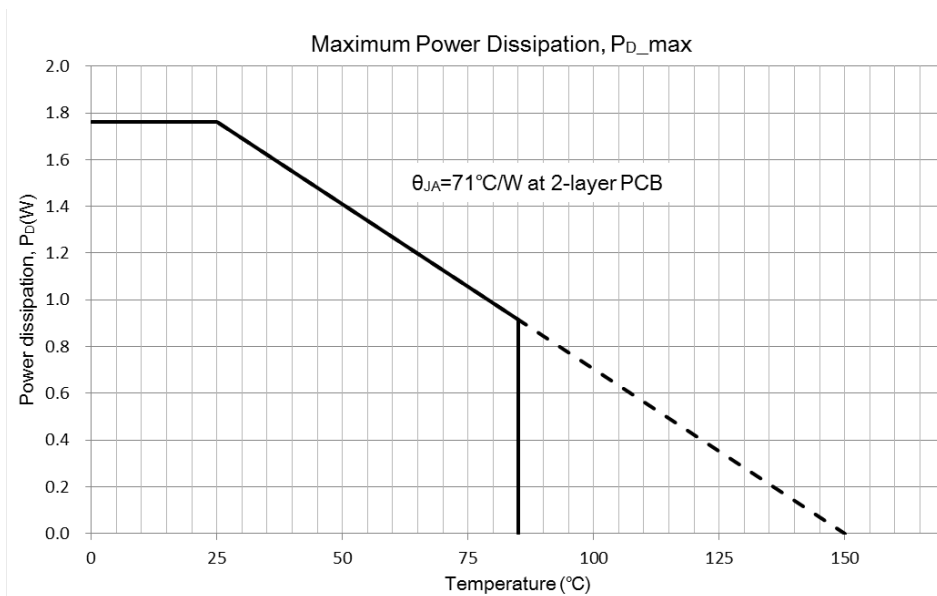


Figure 2. Maximum Power Dissipation

**WARNING:** Operation at or beyond these limits may result in permanent damage to the device. Normal operation is guaranteed at these extremes.

## 7. Recommended Operating Conditions

(Ta = 25°C, unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Control Supply Voltage	VC	2.7	3.0	5.5	V	
Motor Driver Supply Voltage	VM	2.0	5.0	9.0	V	
Input Pulse Frequency	FIN	-	-	1000	kHz	50%duty
Operating Temperature Range	Ta	-30	-	85	°C	

## 8. Electrical Characteristics

(Ta = 25°C, VM=5.0V, VC = 3.0V, unless otherwise specified)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
<b>Quiescent Current</b>						
VM Quiescent Current at Power Off	I <sub>VMPOFF</sub>	EN="L" All internal circuits are power off.	-	-	1.0	μA
VC Quiescent Current at Power Off	I <sub>VCPOFF</sub>		-	-	1.0	μA
VM Quiescent Current at Standby	I <sub>VMSTBY</sub>	EN="H", SEL="L" INnA="L", INnB="L"	-	40	200	μA
VC Quiescent Current at Standby	I <sub>VCSTBY</sub>		-	150	500	μA
VC Quiescent Current at PWM Operation	I <sub>VCPWM1</sub>	FIN=1000kHz(INnA), SEL="L", INnB="H" Duty=50%	-	2.0	5.0	mA
	I <sub>VCPWM2</sub>	FIN=1000kHz(INnB), SEL="L", INnA="H" Duty=50%	-	3.3	10.0	mA
<b>Charge Pump</b>						
Charge Pump Voltage	VG	VG=VC+VM, Iload=0A	7.0	7.5	8.0	V
Charge Pump Wake Up Time	t <sub>VGON</sub>	VG=VC+VM-1.0V	-	0.3	3.0	ms
<b>Motor Driver</b>						
Driver On-resistance (High side + Low side)	R <sub>ON1</sub>	Iload=100mA, Ta=25°C	-	0.35	0.46	Ω
Driver On-resistance (High side + Low side) (Note 6)	R <sub>ON2</sub>	Iload=0.7A, Ta=25°C	-	0.38	0.53	Ω
Driver On-resistance (High side + Low side) (Note 6)	R <sub>ON3</sub>	Iload=0.7A, Ta=85°C	-	0.48	0.72	Ω
Body Diode Forward Voltage	V <sub>FMD</sub>	I <sub>F</sub> =100mA	-	0.8	1.2	V
H-Bridge Propagation Delay Time (L→H)	t <sub>PDH</sub>	tr=tf=10ns, 1kΩ Load between OUTnA and OUTnB. (Figure 3 (a))	-	-	0.5	μs
H-Bridge Propagation Delay Time (H→L)	t <sub>PDL</sub>		-	-	0.5	μs
H-Bridge Propagation Delay Time (Hi-Z→"H") (Note 6)	t <sub>PDZH</sub>		-	-	0.5	μs
H-Bridge Propagation Delay Time (Hi-Z→"L") (Note 6)	t <sub>PDZL</sub>		-	-	0.5	μs
H-Bridge Output Pulse Width (Note 6)	t <sub>PWO</sub>	20Ω Load between OUTA and OUTB. Input Pulse Width t <sub>PWI</sub> : 100ns(Figure 3 (b))	35	85	135	ns

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
<b>Control Logic</b>						
Input High Level Voltage (INnA, INnB, SEL and EN)	$V_{IH}$	$V_C=2.7V\sim 5.5V$	0.7 $\times V_C$	-	-	V
Input Low Level Voltage (INnA, INnB, SEL and EN)	$V_{IL}$		-	-	0.3 $\times V_C$	V
Input High Level Current (INnA and INnB)	$I_{IH1}$	$V_{IH}=3.0V$	-1.0	0	1.0	$\mu A$
Input High Level Current (SEL and EN)	$I_{IH2}$	$V_{IH}=3.0V$	9	15	21	$\mu A$
Input Low Level Current (INnA, INnB, SEL and EN)	$I_{IL}$	$V_{IL}=0V$	-1.0	-	1.0	$\mu A$
<b>Protection</b>						
VC Under-voltage Detect Voltage	$V_{C_{UV}}$		1.9	2.2	2.5	V
Voltage Hysteresis	$V_{C_{UVHYS}}$	Design guarantee (Note 6)	0.02	0.05	0.2	V
Thermal Shutdown temperature	$T_{DET}$	Design guarantee (Note 6)	150	175	200	$^{\circ}C$
Temperature Hysteresis	$T_{DETHYS}$	Design guarantee (Note 6)	15	25	35	$^{\circ}C$

Note 6. Not tested in production.

Note 7. 10Ω Load between OUTnA/B and GND. 10Ω Load between OUTnA/B and VM.

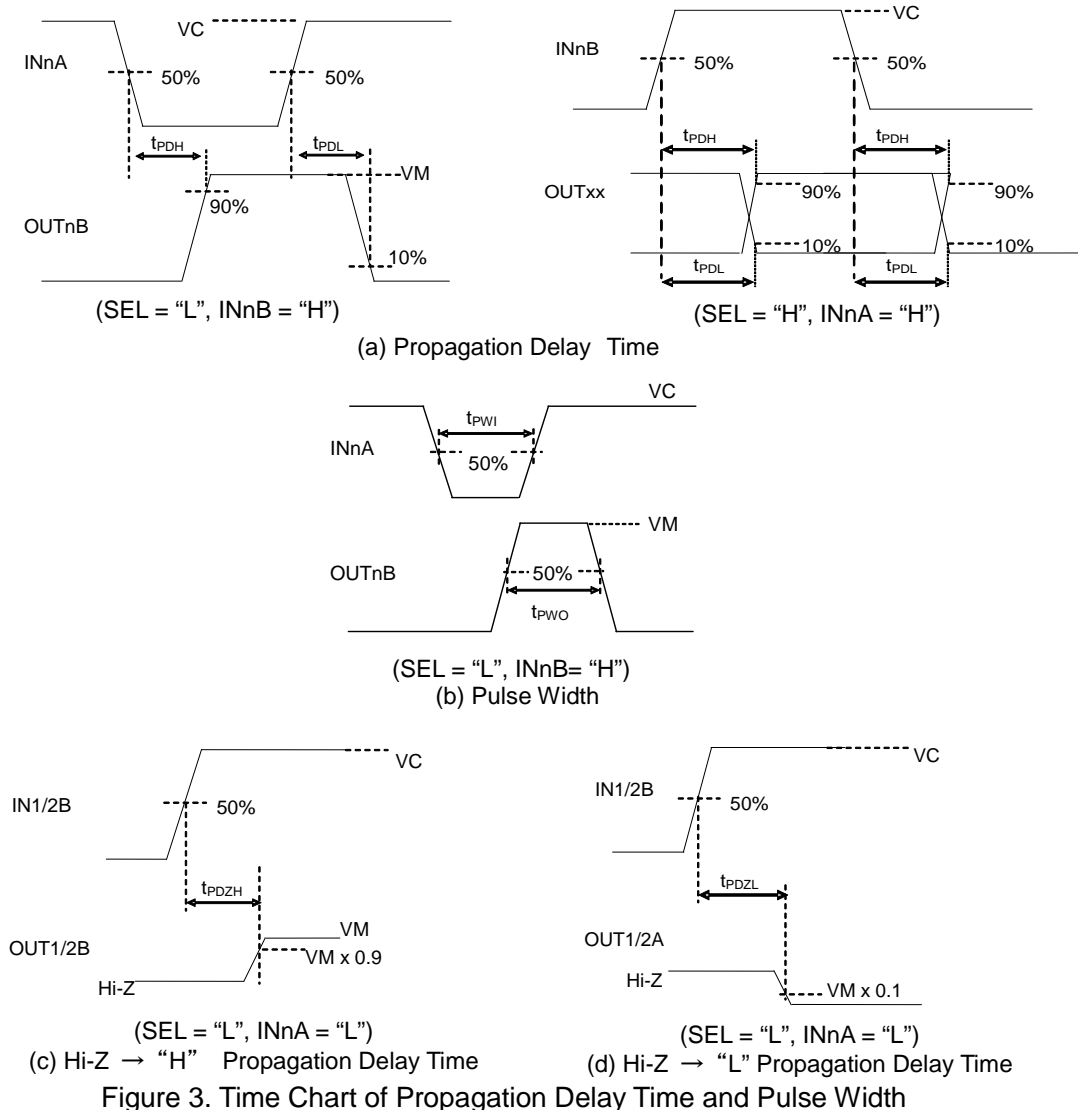


Figure 3. Time Chart of Propagation Delay Time and Pulse Width

**9. Functional Descriptions**

The AP1019 is a motor driver IC for stepping and voice coil motors. The output status (OUT1A, OUT1B, OUT2A, OUT2B) can be controlled by the input signals as shown in Table 1. The AP1019 has the under voltage detection and thermal shutdown functions. When the control power supply voltage (VC) becomes lower than the specified value, the H-Bridge driver outputs are set to Hi-Z by the under-voltage detection circuit (UVD). When abnormal internal high temperature is detected, the thermal shutdown function prevents damages from self-heating by setting OUTA and OUTB outputs Hi-Z.

**9.1 Control Logic**

The relations of the input and output with each mode are as follows.

Table 1. Output Status and Operation Mode according to Input Combinations

Input				Output		Motion
EN	SEL	INnA	INnB	OUTnA	OUTnB	
H	L	L	L	Z	Z	Standby (Idling)
		L	H	L	H	Reverse (CCW)
		H	L	H	L	Forward (CW)
		H	H	L	L	Brake (Stop)
	H	L	X	L	L	Brake (Stop)
		H	L	H	L	Forward (CW)
		H	H	L	H	Reverse (CCW)
L	X	X	X	Z	Z	Power off (Idling)

- EN Signal  
Select Power ON/OFF status of the AP1019.  
The AP1019 goes power-off state by setting the EN pin = "L". The output becomes OFF (Hi-Z) and the charge pump stops operation.
- SEL Signal  
Select control logic
- INnA and INnB Signal  
Control H-Bridge driver output status. H-Bridge statuses of each operation are shown in Figure 4.

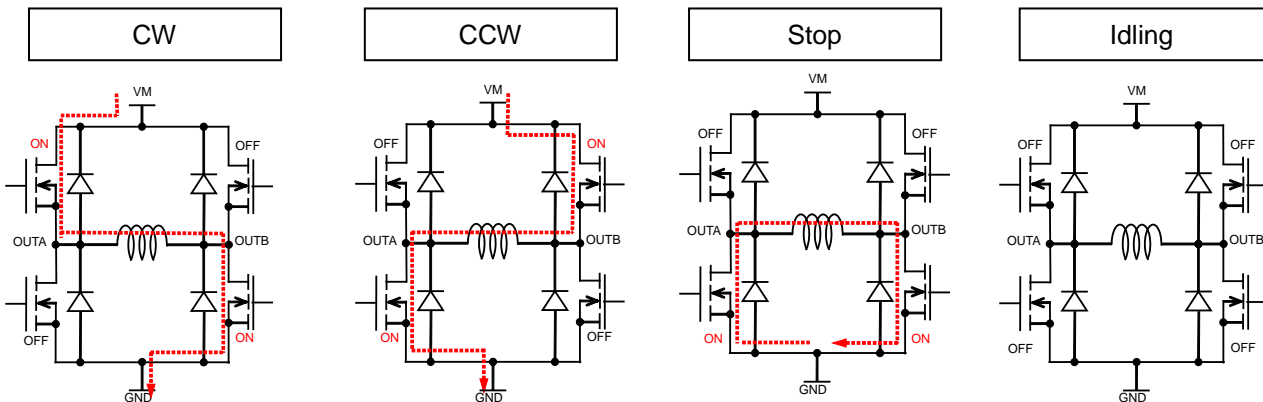


Figure 4. H-Bridge Driver Operation Status



**9.2 Protection Functions**

The AP1019 has shoot-through current prevention, thermal shutdown and under voltage detection circuits.

• Shoot-through Current Prevention Circuit

In order to prevent high side and low side MOSFETs from turning on at the same time, a through current prevention circuit is built in.

MOSFETs are turned off for both high side and low side during the dead time period that is when the shoot-through current prevention circuit is in operation. The dead time is included in the H-Bridge output delay time of the electrical characteristics. Figure 5 shows the signal timing images.

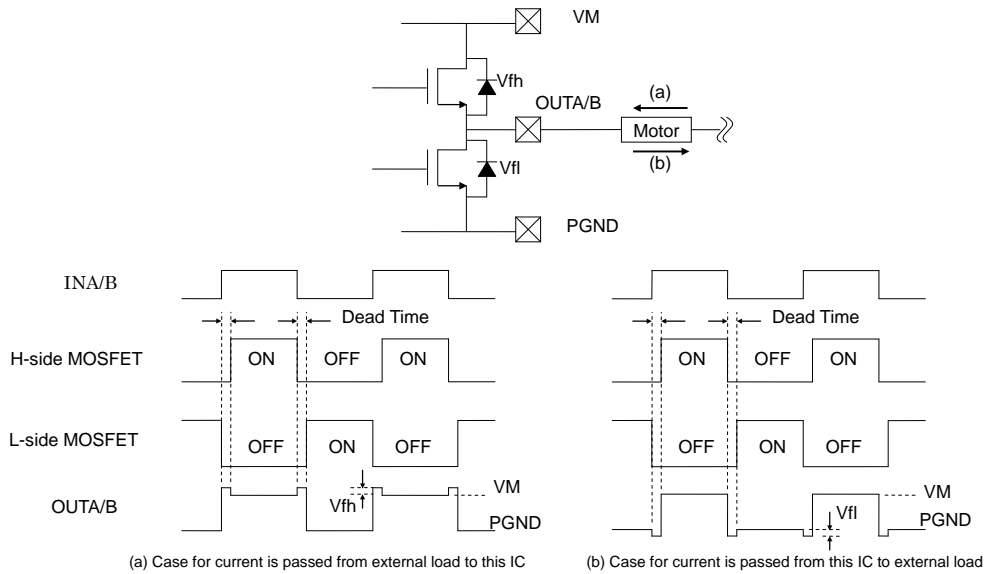


Figure 5. Difference In Output Terminal By Load Current Direction

• Thermal Shut Down (TSD)

The AP1019 prevents damages from self-heating by setting OUTA and OUTB outputs Hi-Z when abnormal high temperature is detected. The AP1019 is able to return to normal operation as soon as the temperature drops to the level lower than the bottom detection threshold.

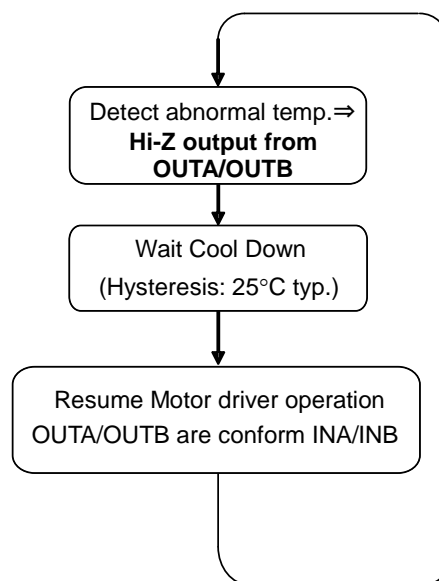


Figure 6. Detection of Abnormal Heat and Returning Normal Operation

• Under-voltage Detection Circuits (UVLO)

The H-Bridge driver outputs become high-impedance by the under-voltage detection circuit (UVD) when the control power supply voltage (VC) is lower than the specified value.

After the low-voltage detection, the H-Bridge driver will be operational when the control power supply voltage (VC) exceeds the value of specified voltage  $VC_{UV} + \text{hysteresis voltage } VC_{UVHYS}$ .

■ Timing Chart

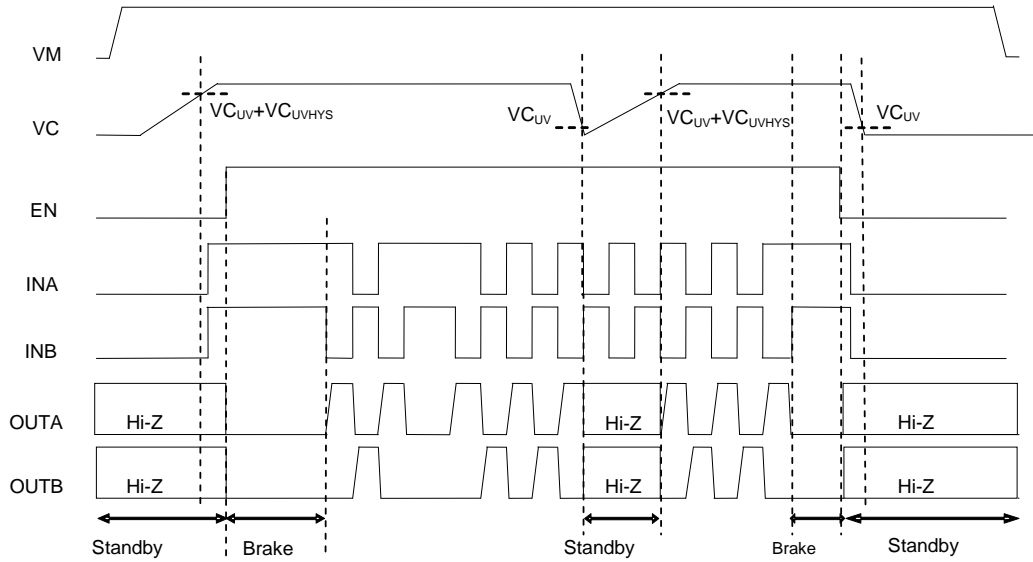


Figure 7. Timing Chart of Input and Output (In Case of Under Voltage Detection, SEL="L")

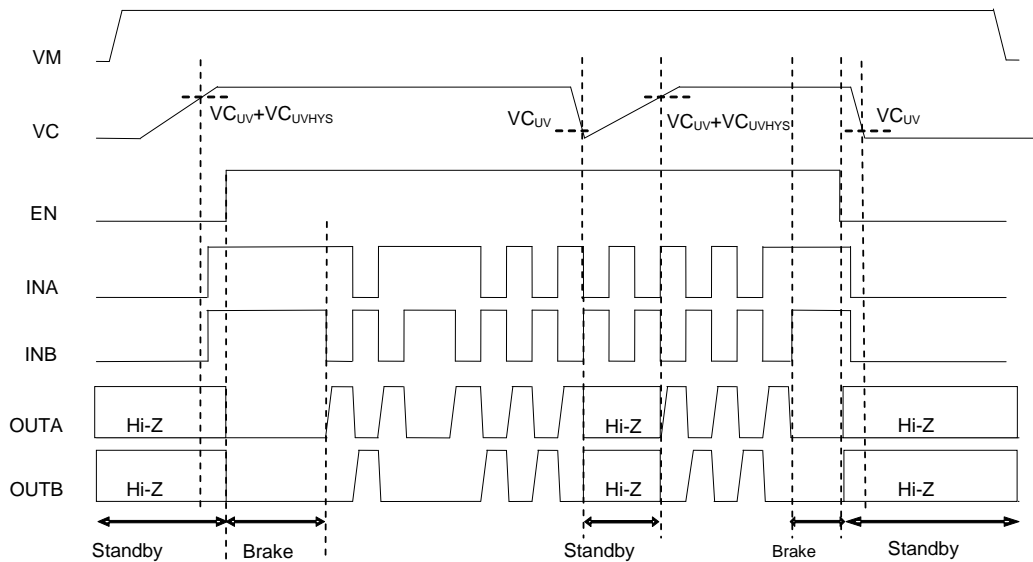


Figure 8. Timing Chart of Input and Output (In Case of TSD Detection, SEL="L")

### 9.3 Linearity Characteristic under PWM Control

AP1019 improves the switching speed between Forward and Reverse control from preceding products, and achieved the good linearity of output current against the PWM input with high frequency.

Condition : VC=3.0V, VM=5.0V, Room Temperature, 680 $\mu$ H + 20 $\Omega$  (7W), SEL="H"

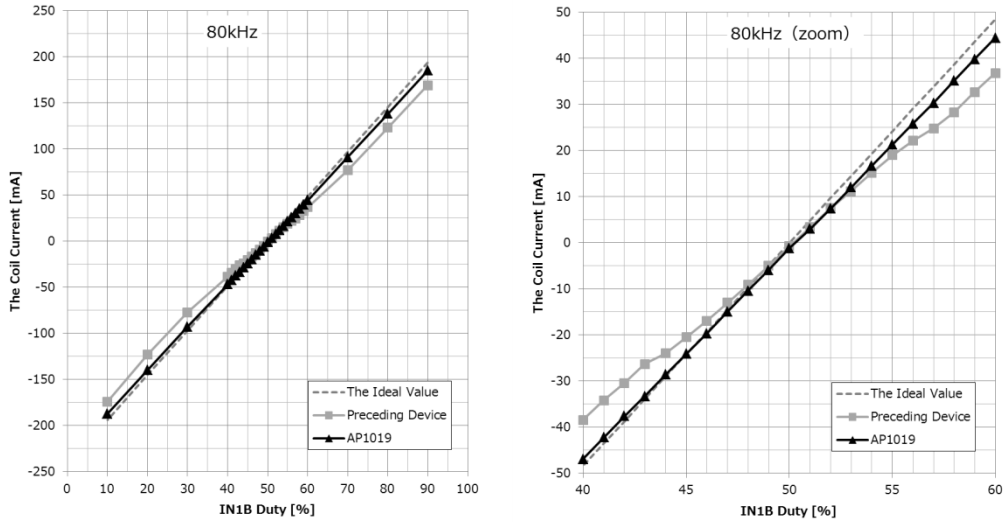


Figure 9. Linearity Characteristic (80kHz)

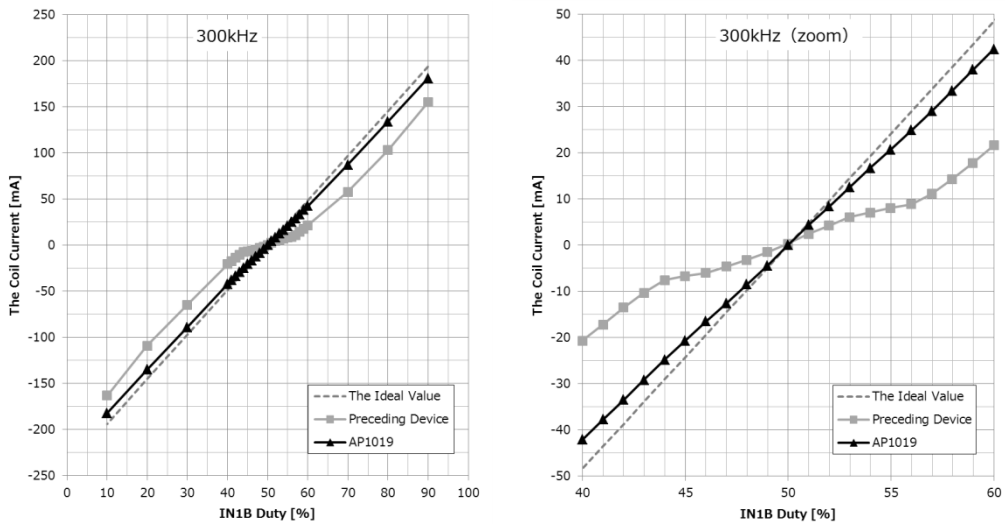


Figure 10. Linearity Characteristic (300kHz)

**10. Recommended External Circuits**

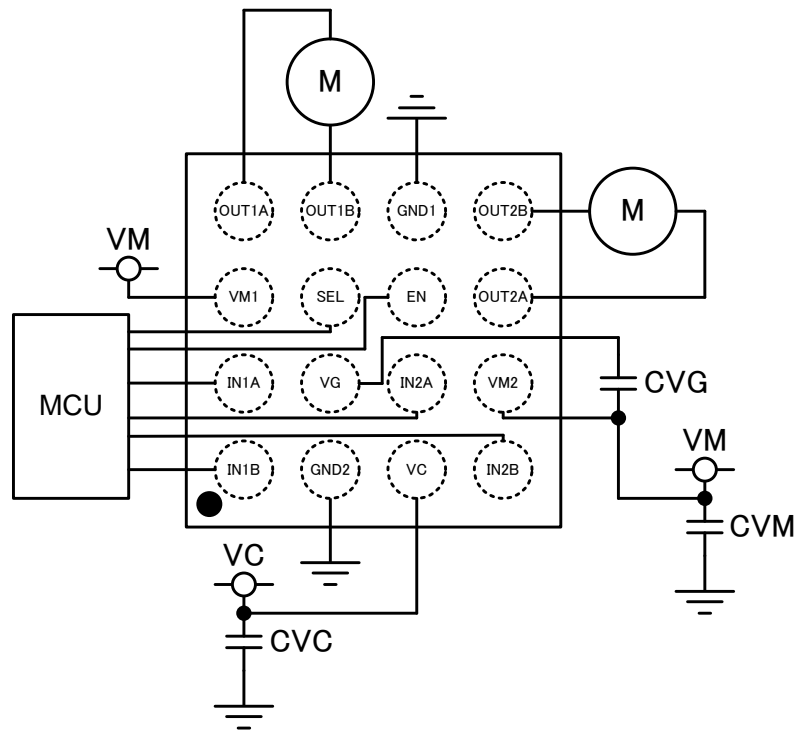


Figure 11. Recommended External Circuit

Table 2 Recommended External Components

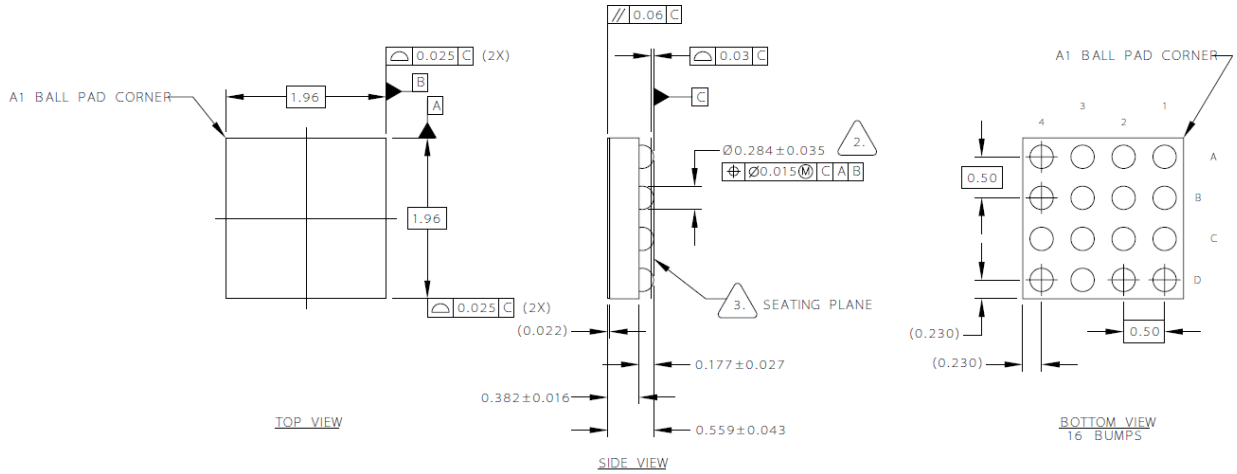
Items	Symbol	Min.	Typ.	Max	Unit	Remarks
Motor Driver Power Supply (decoupling capacitor)	CVM	1.0	10	-	μF	(Note 8)
VC Control Power Supply (decoupling capacitor)	CVC	0.1	1.0	-	μF	
Charge Pump Capacitor 1	CVG	0.047	0.1	0.22	μF	

Note 8. Above values are examples. Please choose appropriate external components for your system board.

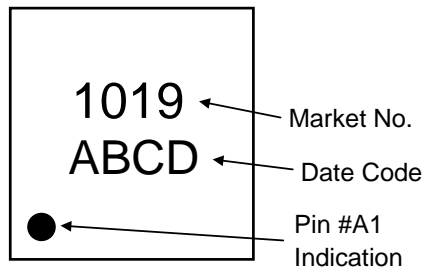
**11. Package**

**11.1. Outline Dimensions**

16-pin WLCSP (1.96mm x 1.96mm)



**11.2. Marking**



ABCD: Date code (4 digit)  
 A: Year Code (Last digit of the year)  
 B, C: Week Code  
 D: Manage number

**12. Ordering Guide**

AP1019AEC    -30~85°C    16-pin WLCSP (1.96mm×1.96mm)

**13. Revision History**

Date (Y/M/D)	Revision	Reason	Page	Contents
17/12/22	0.0	First Edition		

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